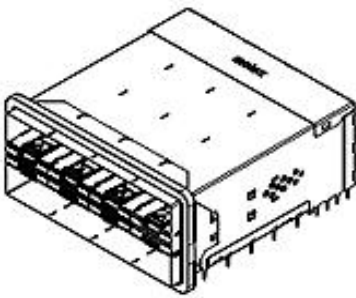




**Part Number :** [1712244011](#)  
**Product Description :** zSFP+ Stacked Ganged Assembly with Metal Spring Fingers, 2-by-4 with 4 Light Pipes, 160 Circuits  
**Series Number :** 171224  
**Status :** Active  
**Product Category :** High-Speed I/O Connectors



## Documents & Resources

### Drawings

[1712244011\\_sd.pdf](#)  
[PK-170071-002-001.pdf](#)

### 3D Models and Design Files


[STEP AP242](#)  
[SOLIDWORKS](#)  
[Creo](#)  
[EE-170071-0001-001.pdf](#)  
[SP-170426-1000-001.zip](#)

### Specifications

[AS-170071-0002-001.pdf](#)  
[PS-170071-0001-001.pdf](#)  
[TS-170071-0001-001.pdf](#)

## Product Environment Compliance

### Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC

	(25 June 2025)
EU RoHS	Compliant per EU 2015/863

#### Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

#### Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

#### Substances of Interest

- PFAS

#### EU RoHS Certificate of Compliance

#### Additional Product Compliance Information

## Part Details

### General

Status	Active
Category	High-Speed I/O Connectors
Series	171224
Description	zSFP+ Stacked Ganged Assembly with Metal Spring Fingers, 2-by-4 with 4 Light Pipes, 160 Circuits
Application	Module-to-Board
Component Type	Receptacle
Product Name	zSFP Plus,zSFP+
Type	Pluggable
UPC	884982823617

### Agency

UL	E29179
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### Electrical

Current - Maximum per Contact	0.5A
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Data Rate	28.0 Gbps
Shielded	Yes
Shield Type	EMI Fingers
Voltage - Maximum	30V AC (RMS)/DC

## Physical

Circuits (Loaded)	160
Color - Resin	Black
Durability (mating cycles max)	100
Flammability	94V-0
Gender	Female
Lock to Mating Part	Yes
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Matte Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	95.833/g
Number of Rows	2
Orientation	Right Angle
Packaging Type	Tray
Panel Mount	No
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Plating min - Mating	0.762μm
Plating min - Termination	0.762μm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	8
Temperature Range - Operating	-40° to +85°C
Termination Interface Style	Through Hole - Compliant Pin

## Solder Process Data

Lead-Free Process Capability	N/A
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This document was generated on Aug 03, 2025